504925204 05/22/2018

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KUEI-MING CHANG	04/27/2018
TA-CHUN LIN	04/27/2018
REI-JAY HSIEH	05/01/2018
YUNG-CHIH WANG	04/27/2018
WEN-HUEI GUO	05/02/2018
KUO-HUA PAN	05/02/2018
BUO-CHIN HSU	05/02/2018

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.	
Street Address:	NO. 8, LI-HSIN RD. 6	
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK	
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15962181

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	DANIEL R. MCCLURE
SIGNATURE:	/Daniel R. McClure/

504925204 PATENT REEL: 045870 FRAME: 0603

DATE SIGNED:	05/22/2018	
Total Attachments: 2		
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PATENT REEL: 045870 FRAME: 0604

ASSIGNMENT

This assignment a	agreement is ap	plicable to an invi	ention entitled (Invention Title)
SEMICONDUCT	OR DEVICE	AND MANUFAC	TURING MET	HOD THEREOF
The PATENT RI	GHTS referred	to in this agreeme	ent are:	
(check one) [a]	patent applicati	on for this inventi	on, executed by	the ASSIGNOR(S)
co	ncurrently with	this assignment.		
⊠U.	S. patent applic	cation Serial No	15/962,181	filed_April 25, 2018
∏a I	J.S. patent app	lication based on I	PCT Internation	al Application
No.		filed on (date)_		(U.S. patent application
Ser	ial No	, if known	<u>).</u>	
		, issued		
The PATENT RI	GHTS also incl	lude all divisions,	reissues, contin	uations and extensions of
the patents and pa	atent applicatio	ns identified abov	e.	
The PATENT RI	GHTS assigned	l under this agreer	nent are:	
(check one) 🛛 U	S. patent rights	only.		
<u></u> ₩	orldwide paten	t rights. In this cas	e, the assignee	shall have the right to
cla	im the benefit	of the filing date o	of any U.S. or fo	oreign patent application
for	r this invention			
The ASSIGNOR	(S) referred to i	n this agreement i	s (or are) the in	ventor(s) whose signatures
appear on page 2	of this Assignr	nent and any Supp	lemental Sheet	(s).
The ASSIGNEE	referred to in th	is agreement is:		
(Name of Assigne	e) TAIWAN S	EMICONDUCTO	R MANUFAC	TURING CO., LTD.
(Address) NO.8.	LI-HSIN RD.6.	SCIENCE-BASE	ED INDUSTRIA	AL PARK, HSINCHU,
TAIWAN 300, R	<u>.O.C.</u>			
The ASSIGNEE	îs:			
(check one) [An	individual.			
∐A P	artnership.			
⊠A €	Corporation of	TAIWAN, R.	O.C. (specify s	state or country)
(oth	ier)			
The ASSIGNOR	(S), in consider	ation of \$10,00 pa	id by the ASSI	GNEE, and other good and
valuable consider	ation, receipt o	f which is acknow	ledged, hereby	assign(s) the following
rights to the ASS	IGNEE, its suc	cessors and assign	is:	
the full and exclu	sive right to the	e invention;		
the entire right, ti	tle and interest	in and to the PAT	ENT RIGHTS;	

the right to sue and recover for any past infringement; and

provisions, based on any earlier patent applications for this invention.

the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable

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THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO ASSIGNEE: TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. INVENTION TITLE: SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation. substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Kuei-Ming CHANG	<u>kuil-ming Charf</u> Signature	2018/4/29
Name of sole or first inventor	Signature /	Date
Ta-Chun LIN	Ta-Chun Um	2018/14/27
Name of second inventor, if any	Signature	Date
Rei-Jay HSIEH	koi-Jay Haleh	20/8/05/01
Name of third inventor, if any	Signature	Date
Yung-Chih WANG	Yuing-Ohih Wang Signature	2018/04/27
Name of fourth inventor, if any	Signature	Date
Wen-Huei GUO	Wenkui Gw	2018/05/02
Name of fifth inventor, if any	Signature	Date
Kuo-Hua PAN	Kuo-Hua, Pan	2018/05/02
Name of sixth inventor, if any	Signature	Date
Buo-Chin HSU	Box- Cha Ksa	20/8 /05/02
Name of seventh inventor, if any	Signature	Date

REEL: 045870 FRAME: 0606

PATENT

RECORDED: 05/22/2018